

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:	T. Haze	Attorney Docket No.:	LEPA122745
Application No.:	10/823,297	Art Unit:	2822 / Confirmation No: 4560
Filed:	April 13, 2004	Examiner:	P.E. Perkins
Title:	METHOD OF FORMING BUMP PAD OF FLIP CHIP AND STRUCTURE THEREOF		

AMENDMENT A

Seattle, Washington 98101

December 18, 2006

TO THE COMMISSIONER FOR PATENTS:

INTRODUCTORY COMMENTS

Please amend the above-identified application as follows.